

## **Absolute Maximum Ratings** (Ta = $25^{\circ}$ C)

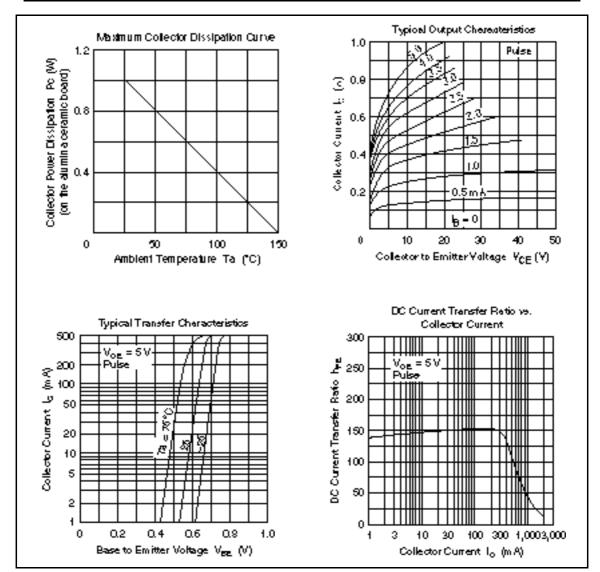
Item	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	180	V
Collector to emitter voltage	V <sub>CEO</sub>	160	V
Emitter to base voltage	$V_{\text{EBO}}$	5	V
Collector current	I <sub>c</sub>	1.5	А
Collector peak current	i <sub>C(peak)</sub> *1	3	А
Collector power dissipation	P <sub>c</sub> * <sup>2</sup>	1	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

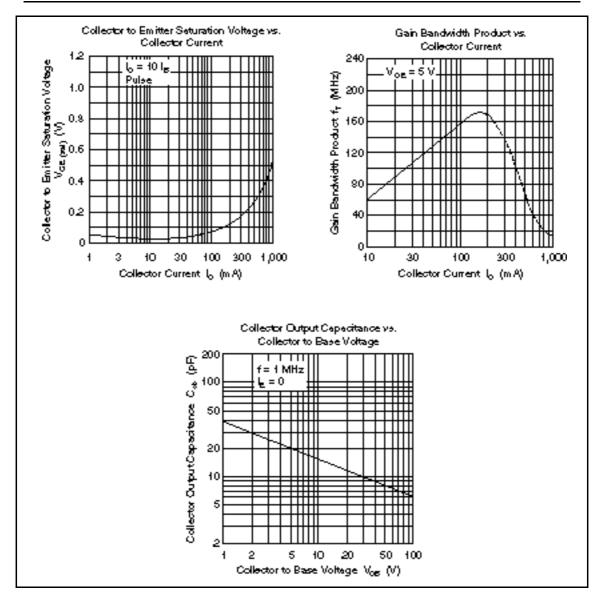
Notes: 1. PW 10 ms, Duty cycle 20%

2. Value on the alumina ceramic board (12.5 x 20 x 0.7 mm)

#### **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	180	_	-	V	$I_{c} = 1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	160	_	_	V	$I_c = 10$ mA, $R_{BE} =$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	5	_	_	V	$I_{\rm E} = 1$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	—	—	10	μA	$V_{CB} = 160 \text{ V}, I_{E} = 0$
DC current transfer ratio	$h_{FE1}^{*1}$	60	_	200		$V_{ce} = 5 \text{ V}, \text{ I}_{c} = 0.15 \text{ A}$
	$h_{\text{FE2}}$	30	_	—		$V_{ce}$ = 5 V, $I_c$ = 0.5 A
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0	V	$I_{\rm C}$ = 0.5 A, $I_{\rm B}$ = 50 mA, Pulse
Base to emitter voltage	$V_{\text{BE}}$	_	_	0.9	V	$V_{ce}$ = 5 V, $I_c$ = 0.15 A, Pulse
Note: 1. The 2SD1421 is grouped by h <sub>FE1</sub> as follows.						
Mark ED E	E					
h <sub>FE1</sub> 60 to 120 10	00 to 200	_				





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